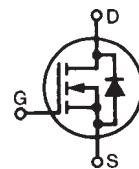


PolarHV™ HiPerFET Power MOSFET

IXFC 20N80P IXFR 20N80P

Electrically Isolated Back Surface

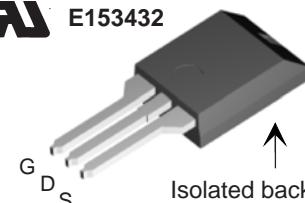
N-Channel Enhancement Mode
Fast Recovery Diode
Avalanche Rated



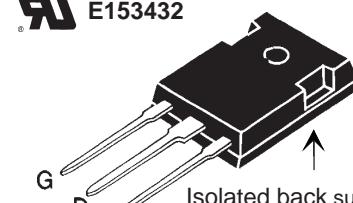
V_{DSS} = 800 V
 I_{D25} = 10 A
 $R_{DS(on)}$ ≤ 500 mΩ
 t_{rr} ≤ 250 ns

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	T_J = 25°C to 150°C	800	V	
V_{DGR}	T_J = 25°C to 150°C; $R_{GS} = 1\text{ M}\Omega$	800	V	
V_{GSS}	Continuous	±30	V	
V_{GSM}	Transient	±40	V	
I_{D25}	$T_c = 25^\circ\text{C}$	11	A	
I_{DM}	$T_c = 25^\circ\text{C}$, pulse width limited by T_{JM}	60	A	
I_{AR}	$T_c = 25^\circ\text{C}$	10	A	
E_{AR}	$T_c = 25^\circ\text{C}$	30	mJ	
E_{AS}	$T_c = 25^\circ\text{C}$	1.0	J	
dv/dt	$I_s \leq I_{DM}$, $di/dt \leq 100\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ\text{C}$, $R_G = 3\Omega$	10	V/ns	
P_D	$T_c = 25^\circ\text{C}$	166	W	
T_J		-55 ... +150	°C	
T_{JM}		150	°C	
T_{stg}		-55 ... +150	°C	
T_L	1.6 mm (0.062 in.) from case for 10 s	300	°C	
V_{ISOL}	50/60 Hz, RMS, t = 1 minute, leads-to-tab	2500	V~	
F_c	Mounting Force (IXFC) (IXFR)	11..65 / 2.5..15 20..120 / 4.5..25	N/lb	
Weight	ISOPLUS220 ISOPLUS247	2 5	g	

ISOPLUS220™ (IXFC)



ISOPLUS247™ (IXFR)



G = Gate D = Drain
S = Source

Features

- Silicon chip on Direct-Copper-Bond substrate
 - High power dissipation
 - Isolated mounting surface
 - 2500V electrical isolation
- Low drain to tab capacitance(<30pF)

Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor control

Advantages

- Easy assembly
- Space savings
- High power density

Symbol	Test Conditions	Characteristic Values		
	($T_J = 25^\circ\text{C}$, unless otherwise specified)	Min.	Typ.	Max.
BV_{DSS}	$V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$	800		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 4\text{ mA}$	3.0		5.0 V
I_{GSS}	$V_{GS} = \pm 30\text{ V}$, $V_{DS} = 0\text{ V}$		±100	nA
I_{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0\text{ V}$		25 1	μA mA
$R_{DS(on)}$	$V_{GS} = 10\text{ V}$, $I_D = 10\text{ A}$ Pulse test, $t \leq 300\text{ }\mu\text{s}$, duty cycle $d \leq 2\%$		500	mΩ

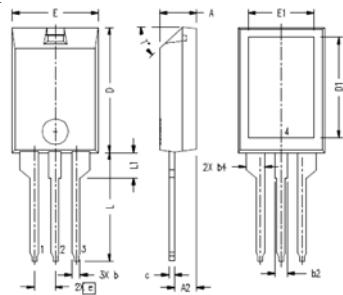
Symbol **Test Conditions**
Characteristic Values
 $(T_J = 25^\circ\text{C}$ unless otherwise specified)

Min. **Typ.** **Max.**

g_{fs}	$V_{DS} = 20 \text{ V}; I_D = 10 \text{ A}$, pulse test	12	23	S
C_{iss} C_{oss} C_{rss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	4680	pF	
		360	pF	
		28	pF	
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	$V_{GS} = 10 \text{ V}, V_{DS} = V_{DSS}, I_D = 10 \text{ A}$ $R_G = 3 \Omega$ (External)	22	ns	
		24	ns	
		70	ns	
		25	ns	
$Q_{g(on)}$ Q_{gs} Q_{gd}	$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_D = 10 \text{ A}$	85	nC	
		25	nC	
		27	nC	
R_{thJC}			0.75	°C/W
R_{thCS}		0.21		°C/W

Source-Drain Diode
Characteristic Values
 $(T_J = 25^\circ\text{C}$ unless otherwise specified)

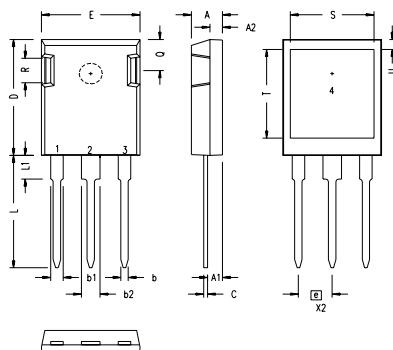
Symbol	Test Conditions	Min.	Typ.	Max.
I_s	$V_{GS} = 0 \text{ V}$		20	A
I_{SM}	Repetitive		60	A
V_{SD}	$I_F = I_s, V_{GS} = 0 \text{ V}$, Pulse test, $t \leq 300 \mu\text{s}$, duty cycle $d \leq 2 \%$		1.5	V
t_{rr} I_{RM} Q_{RM}	$I_F = 20 \text{ A}, -di/dt = 100 \text{ A}/\mu\text{s}$ $V_R = 100 \text{ V}; V_{GS} = 0 \text{ V}$		250	ns
			8	A
			0.8	μC

ISOPLUS220 (IXFC) Outline


Note:
Bottom heatsink (Pin 4) is electrically isolated from Pin 1,2, or 3.

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
c	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
E	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
e	.100	BASIC	2.55	BASIC
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
T*			42.5*	47.5*

IXYS CO 0177 R0

ISOPLUS247 (IXFR) Outline


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b1	.075	.084	1.91	2.13
b2	.115	.123	2.92	3.12
C	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
E	.620	.635	15.75	16.13
e	.215	BSC	5.45	BSC
L	.780	.800	19.81	20.32
L1	.150	.170	3.81	4.32
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.520	.540	13.21	13.72
T	.620	.640	15.75	16.26
U	.065	.080	1.65	2.03

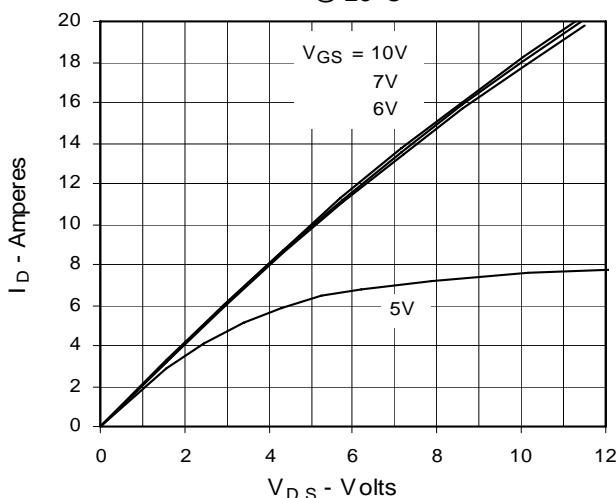
1 – GATE
2 – DRAIN (COLLECTOR)
3 – SOURCE (EMITTER)
4 – NO CONNECTION

NOTE: This drawing will meet all dimensions requirement of JEDEC outline TO-247AD except screw hole.

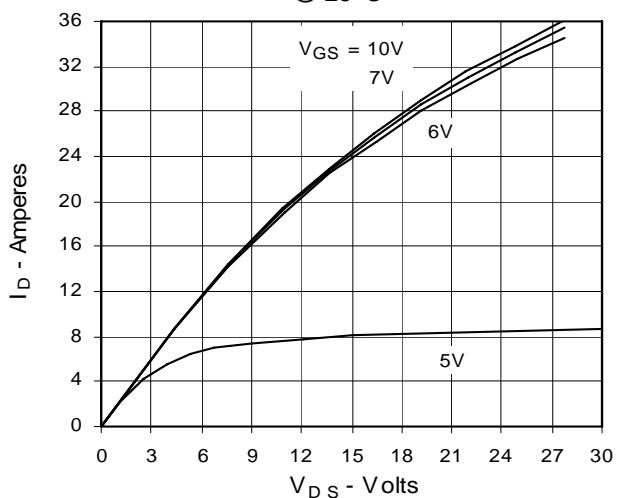
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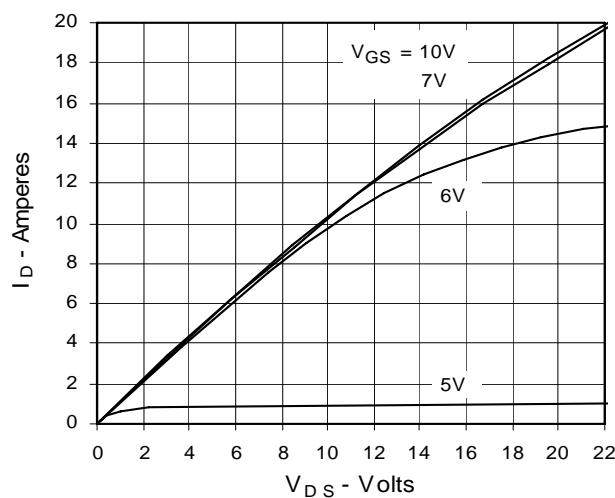
**Fig. 1. Output Characteristics
@ 25°C**



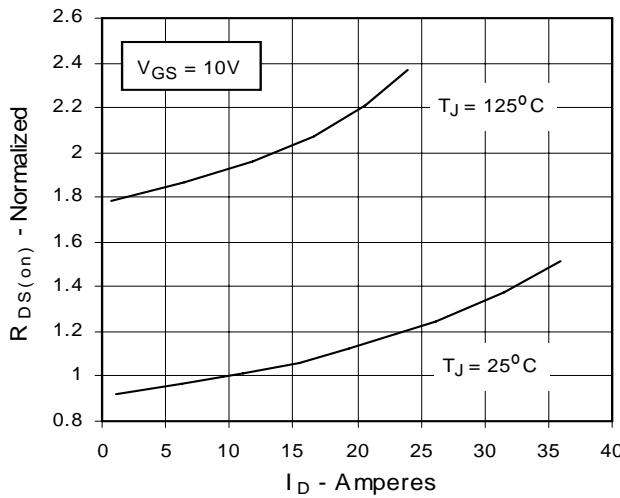
**Fig. 2. Extended Output Characteristics
@ 25°C**



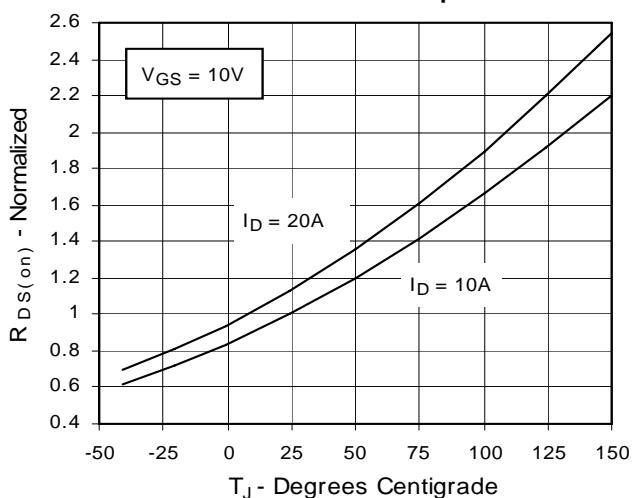
**Fig. 3. Output Characteristics
@ 125°C**



**Fig. 5. $R_{DS(on)}$ Normalized to
 $I_D = 10A$ Value vs. Drain Current**



**Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 10A$
Value vs. Junction Temperature**



**Fig. 6. Drain Current vs. Case
Temperature**

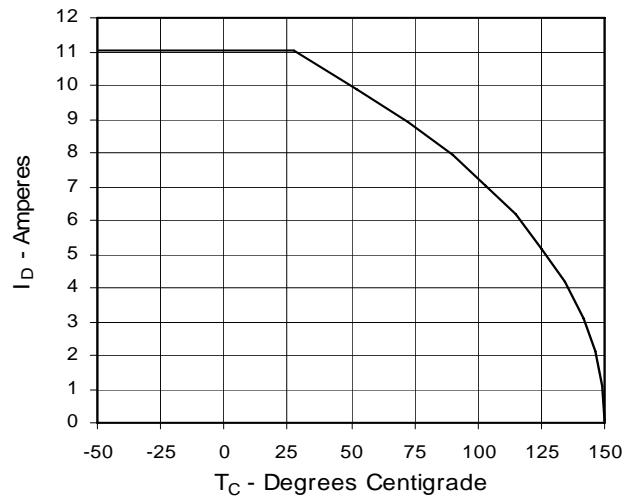
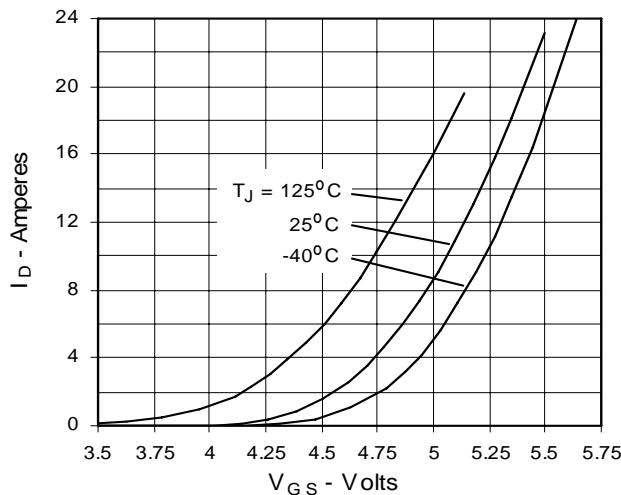
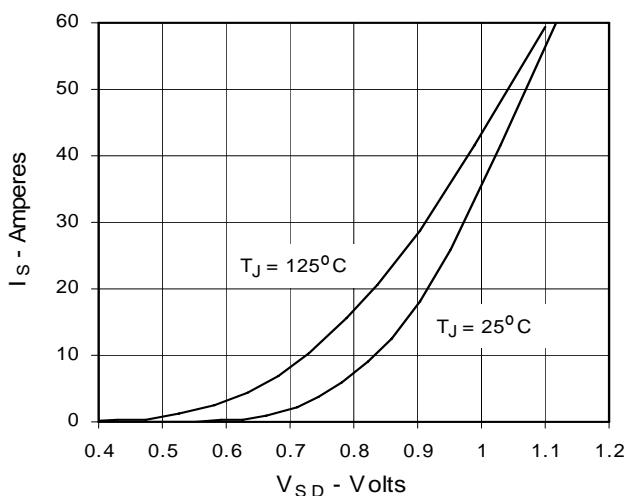
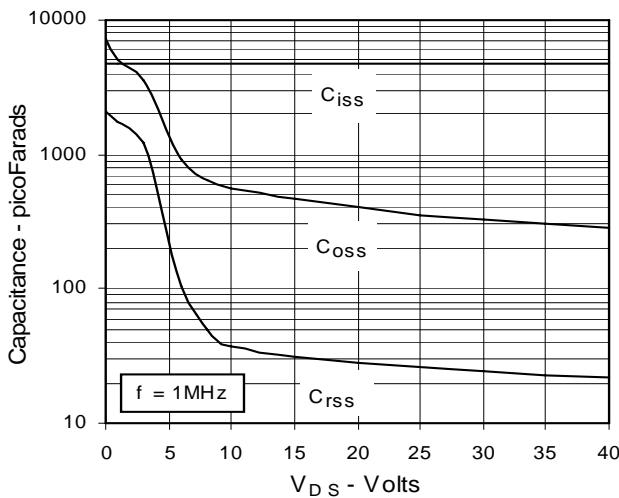
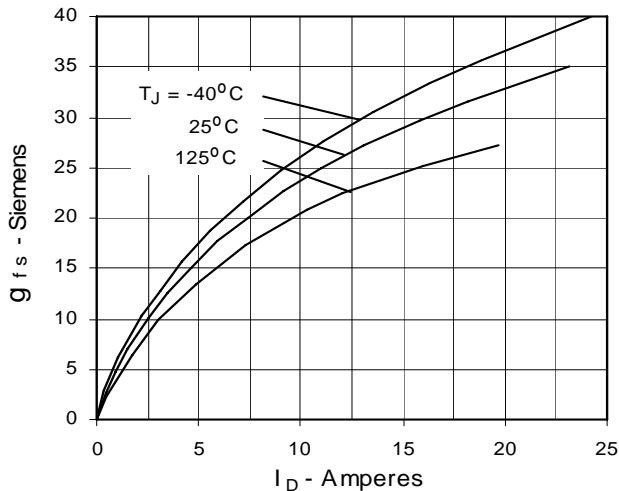
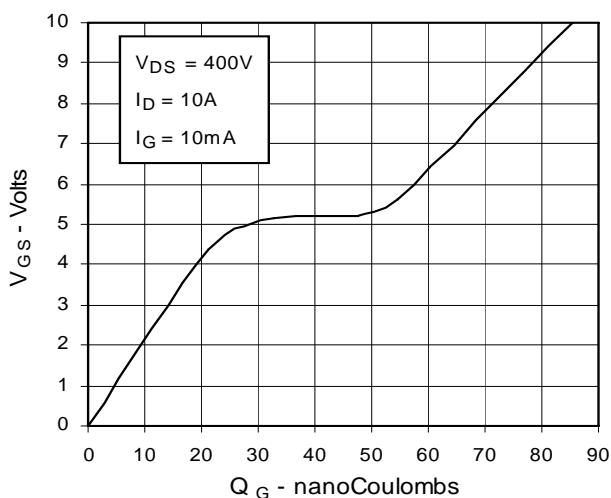
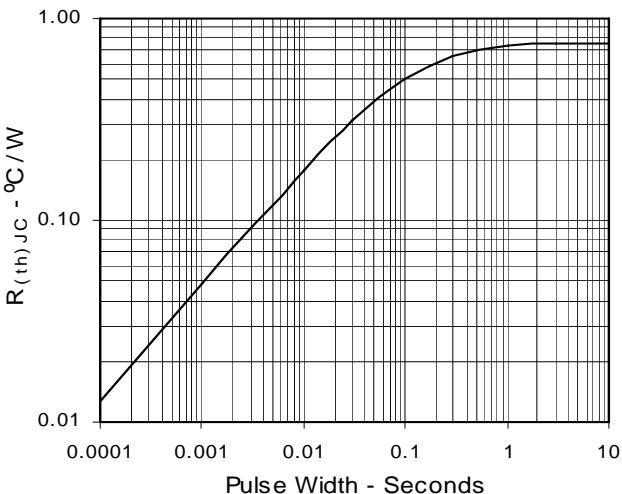


Fig. 7. Input Admittance

**Fig. 9. Source Current vs.
Source-To-Drain Voltage**

Fig. 11. Capacitance

Fig. 8. Transconductance

Fig. 10. Gate Charge

Fig. 12. Maximum Transient Thermal Resistance




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